

Travel Grant Application Las Vegas, Nevada

The Society's Battery, Corrosion, Dielectric Science & Technology, Electrodeposition, Electronics and Photonics, Energy Technology, High Temperature Materials (HTM), Industrial Electrochemistry and Electrochemical Engineering (IE&EE), Organic and Biological Electrochemistry (OBE), Physical and Analytical Electrochemistry, and Sensor Divisions offer travel grants to students presenting papers at the Society's next meeting, in Las Vegas, Nevada, October 10-15, 2010. To apply, complete this application and send it along with a copy of your transcript and a letter from an involved faculty member attesting both to the quality of the student's work and financial needs, and a copy of the student's meeting abstract. For additional information please contact the Division contact below, as requirements might differ between Divisions.

Meeting Site: _____

Name: _____

School Address: _____

Email: _____ Phone #: _____

Undergraduate Year (U) or Graduate Year (G) - circle one: U3 U4 G1 G2 G3 G4 G5

Major Subject: _____ Grade point average: _____ out of possible: _____

(please provide a letter of recommendation from your faculty advisor and a copy of your transcript)

Symposium Title (#): _____

Title of paper to be presented at the meeting: _____

Are you an ECS Student Member of the Society? ☐ yes ☐ no

(if not, please additionally submit the Awarded Student Membership application)

Estimated meeting expenditures: \$ _____

Signature: _____ Date: _____

Check only one Division. (*Applications made to multiple Divisions will be rejected.*)

- ☐ Battery—*Send to:* Daniel Doughty, Battery Safety Consulting, Inc., 139 Big Horn Ridge Dr. NE, Albuquerque, NM 87122-1903, USA, e-mail: dhdoughty@gmail.com
- ☐ Corrosion—*Send to:* N. Missert, Sandia National Labs, MS 1415, P.O. Box 5800, Albuquerque, NM 87185-0100, USA, e-mail: namisse@sandia.gov
- ☐ Dielectric Science & Technology—*Send to:* H. Rathore, IBM, Retired, e-mail: rathore@yahoo.com
- ☐ Electrodeposition—*Send to:* Stanko Brankovic, University of Houston, Dept. of ECE, Bldg. 1 N308, Houston, TX 77204, USA, e-mail: stanko.brankovic@mail.uh.edu
- ☐ Electronics and Photonics—*Send to:* F. Ren, University of Florida, Dept. of Chem. Engr., Gainesville, FL 32611, USA, e-mail: ren@che.ufl.edu
- ☐ Energy Technology—*Send to:* Matthew Mench, Penn State University, Dept. of Mech. Eng., 327 Reber Bldg., University Park, PA 16802, USA, e-mail: mmench@psu.edu
- ☐ HTM—*Send to:* Tim Armstrong, Carpenter Technology, Bldg. 68, P.O. Box 14662, Reading, PA 19612, USA, e-mail: tarmstrong@cartec.com
- ☐ IE&EE—*Send to:* G. Venkat Subramanian, Department of Energy, Environment, and Chemical Engineering, Washington University, St. Louis, MO 63130 USA, e-mail: vsubramanian@seas.wustl.edu
- ☐ OBE—*Send to:* I. Taniguchi, Kumamoto University, Fac. of Appl. Chem & Biochem., 2-39-1 Kurokami, Kumamoto 860-8555, Japan, e-mail: taniguch@gpo.kumamoto-u.ac.jp
- ☐ Physical and Analytical Electrochemistry—*Send to:* Pawel J. Kulesza, University of Warsaw, Dept. of Chemistry, Krakowskie Przedmiescie 26/28, Warsaw, PL-00-927, Poland, e-mail: pkulesza@chem.uw.edu.pl
- ☐ Sensor—*Send to:* Y-L. Chang, Nanomix, Inc., 5980 Horton Street, Suite 600, Emeryville, CA 94608, USA, e-mail: ychang@nano.com

Applications for Travel Grants for the Las Vegas, Nevada meeting must be received no later than May 7, 2010.